

PCN-2014-562 CS8420-CSZ(R)/D1, CS8420-DSZ(R)/D1, CS8416-CSZ(R)/E, CS8416-DSZ(R)/E Assembly Tooling Change Information Only

Date: 14th October 2014

Dear Customer:

This is an Information Only announcement for an assembly tooling change on CS8420-CSZ(R)/D1, CS8420-DSZ(R)/D1, CS8416-CSZ(R)/E, CS8416-DSZ(R)/E material.

The changes discussed within this PCN are for your information only. Please see the attachment details and supporting documents.

This notification is per the Cirrus Logic standard communication process. Any inquiries should be directed to your local Field Sales Representative.

Sincerely,

Cirrus Logic Corporate Quality Phone: +1(512) 851-4000

Attachment: 1

Products Affected:

CS8420-CSZ(R)/D1, CS8420-DSZ(R)/D1, CS8416-CSZ(R)/E, CS8416-DSZ(R)/E

The devices listed on this page are the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

Technical details of this assembly tooling change follow on the next page(s).

PCN Number:			2014-562 P			PC	CN Date:			October 2014	
Title:	Title: Information Only announcement of Assembly Tooling Change on CS8420-CSZ(R)/D1, CS8420-DSZ(R)/D1, CS8416-CSZ(R)/E, CS8416-DSZ(R)/E material currently offered by Cirrus Logic.										
Customer L Contact: R		Local Fi Represe	eld Sa entati	ales ve	Phone:	(512) 851-4000			Dept:	Corporate Quality	
Proposed 1 st Ship Dat			:	Not Applicable	Estimated Sample Availability date:			le :		Not Applicable	
Change Type:			Assembly Tooling Change. Change Type = Minor								
Assembly Site			\square	Assembly Process				Asse	embly M	laterials	
Design				Electrical Specification / Data Sheet				Мес	hanical	Specification	
Test Site				Packing/Shipping/Labeling				Test Process			
Wafer Bump Site		mp		Wafer Bump Material				Waf	er Bum	p Process	
Wafer Fab Site		b Site		Wafer Fab Mater	ials			Waf	er Fab I	Process	

PCN Details

Description of Change:

The following items related to the assembly tooling change are:

- Single strand format from (12 units per strip) \rightarrow to a Matrix format (32 units per strip)
- Flat backside flag design \rightarrow Dimpled backside flag design

Reason for Change:

Cirrus Logic was informed by our assembly subcontractor (ANST) they will obsolete the single strand format and replace with a Matrix format. Along with the format change, additional performance improvements were made.

- Matrix format increases unit count per strip from 12 to 32, resulting in manufacturing efficiency improvement.
- Dimple design features on the flag backside serve as mold-lock features to improve backside flag to mold compound adhesion.



The Qualification Plans are designed using AEC, JEDEC, and other applicable industry standards.

CS8416-CSZ/E Qualification

CS8416-CSZ/E Qualification: Plan Test Results

Parameter	Comparison Basis	Sample Size	Success Criteria	Test Results
Wire Pull	JEDEC criteria	1 Lot (22 wires)	>3g	Pass
Ball Shear	JEDEC criteria	1 Lot (22 wires)	>15g	Pass
Die Shear	JEDEC criteria	1 Lot (5 units)	>5kg	Pass
Physical Dimen	<i>Case Outline</i>	1 Lot (22 units)	Per package drawing	Pass
Solderability	JEDEC criteria	2 Lots (5 units each)	Wetting area >95%	Pass
MSL 3 + 260C Precon	JEDEC criteria	1 Lot (270 units)	Pass electrical test	0/270
MSL 3 + 260C Precon	JEDEC criteria	3 Lot (22 units each)	No delamination	Pass
MSL 3 + 260C Precon + 500 TC	<i>JEDEC criteria -65C <-> +150C</i>	1 Lot (100 units)	Pass electrical test	0/100
Post TC Wire Pull	AEC Q100	5 units	>3g	0/5

Notes:

• Qualification tests "pass" on zero fails for each test

• CS8416-CSZ/E serves as the Qualification Vehicle for CS8420-CSZ(R)/D1, CS8420-DSZ(R)/D1, and CS8416-DSZ(R)/E.

Reliability Qualification Results:

The Reliability Qualification testing has successfully completed and passed all testing.

Cirrus Logic